SEMIKRON

SKiiP 32 NAB 12

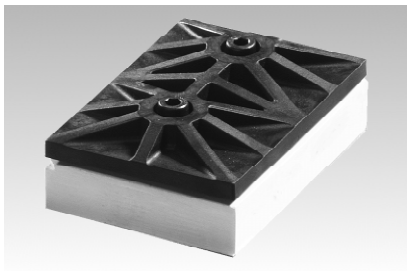
Absolute Maximum Ratings			
Symbol	**Conditions** [1]	**Values**	**Units**
Inverter			
V_{CES}		1200	V
V_{GES}		± 20	V
I_C	$T_{heatsink}$ = 25 / 80 °C	65 / 45	A
I_{CM}	t_p < 1 ms; $T_{heatsink}$ = 25 / 80 °C	130 / 90	A
$I_F = -I_C$	$T_{heatsink}$ = 25 / 80 °C	60 / 40	A
$I_{FM} = -I_{CM}$	t_p < 1 ms; $T_{heatsink}$ = 25 / 80 °C	120 / 80	A
Bridge Rectifier			
V_{RRM}		1500	V
I_D	$T_{heatsink}$ = 80 °C	35	A
I_{FSM}	t_p = 10 ms; sin. 180 °, T_j = 25 °C	700	A
I^2t	t_p = 10 ms; sin. 180 °, T_j = 25 °C	2400	A^2s
T_j		– 40 . . . + 150	°C
T_{stg}		– 40 . . . + 125	°C
V_{isol}	AC, 1 min.	2500	V

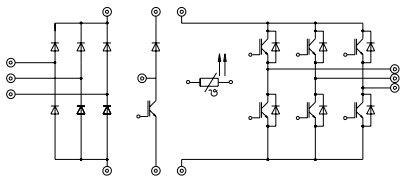
Characteristics					
Symbol	**Conditions** [1]	**min.**	**typ.**	**max.**	**Units**
IGBT - Inverter					
V_{CEsat}	I_C = 50 A T_j = 25 (125) °C	–	2,5(3,1)	3,0(3,7)	V
$t_{d(on)}$	V_{CC} = 600 V; V_{GE} = ± 15 V	–	44	100	ns
t_r	I_C = 50 A; T_j = 125 °C	–	56	100	ns
$t_{d(off)}$	$R_{gon} = R_{goff}$ = 22 Ω	–	380	500	ns
t_f	inductive load	–	70	100	ns
$E_{on} + E_{off}$		–	13	–	mJ
C_{ies}	V_{CE} = 25 V; V_{GE} = 0 V, 1 MHz	–	3,3	–	nF
R_{thjh}	per IGBT	–	–	0,5	K/W
IGBT - Chopper					
V_{CEsat}	I_C = 25 A T_j = 25 (125) °C	–	2,5(3,1)	3,0(3,7)	V
$t_{d(on)}$	V_{CC} = 600 V; V_{GE} = ± 15 V	–	75	150	ns
t_r	I_C = 25 A; T_j = 125 °C	–	65	130	ns
$t_{d(off)}$	$R_{gon} = R_{goff}$ = 47 Ω	–	400	600	ns
t_f	inductive load	–	50	100	ns
$E_{on} + E_{off}$		–	6,2	–	mJ
C_{ies}	V_{CE} = 25 V; V_{GE} = 0 V, 1 MHz	–	1,65	–	nF
R_{thjh}	per IGBT	–	–	1,0	K/W
Diode [2] - Inverter & Chopper					
$V_F = V_{EC}$	I_F = 50 A T_j = 25 (125) °C	–	2,0(1,8)	2,5(2,3)	V
V_{TO}	T_j = 125 °C	–	1,0	1,2	V
r_T	T_j = 125 °C	–	16	22	mΩ
I_{RRM}	I_F = 50 A, V_R = – 600 V	–	40	–	A
Q_{rr}	di_F/dt = – 800 A/µs	–	8,0	–	µC
E_{off}	V_{GE} = 0 V, T_j = 125 °C	–	2,0	–	mJ
R_{thjh}	per diode	–	–	1,0	K/W
Diode - Rectifier					
V_F	I_F = 35 A, T_j = 25 °C	–	1,2	–	V
R_{thjh}	per diode	–	–	1,6	K/W
Temperature Sensor					
R_{TS}	T = 25 / 100 °C		1000 / 1670		Ω
Mechanical Data					
M_1	case to heatsink, SI Units	2	–	2,5	Nm
Case	mechanical outline see page B 16 – 9		M3		

* For diagrams of the Chopper IGBT please refer to SKiiP 30 NAB 12

MiniSKIIP 3
SEMIKRON integrated intelligent Power
SKiiP 32 NAB 12
3-phase bridge rectifier + braking chopper + 3-phase bridge inverter

Case M3





UL recognized file no. E63532

- specification of temperature sensor see part A
- common characteristics B 16 – 4

Options

- also available with powerful chopper. For characteristics please refer to Inverter IGBT

[1] $T_{heatsink}$ = 25 °C, unless otherwise specified
[2] CAL = Controlled Axial Lifetime Technology (soft and fast recovery)

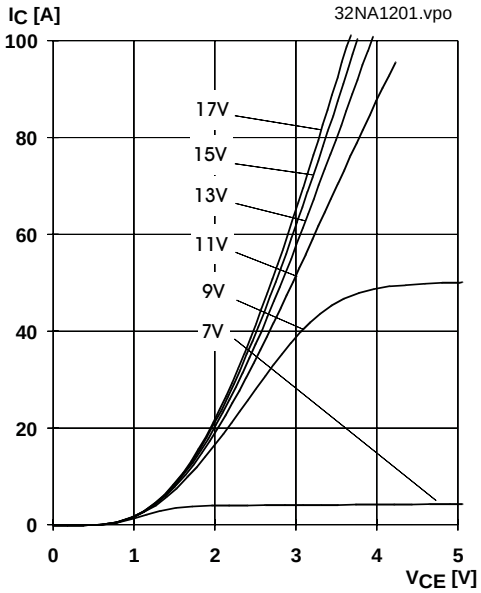


Fig. 1 Typ. output characteristic, t_p = 80 µs; 25 °C

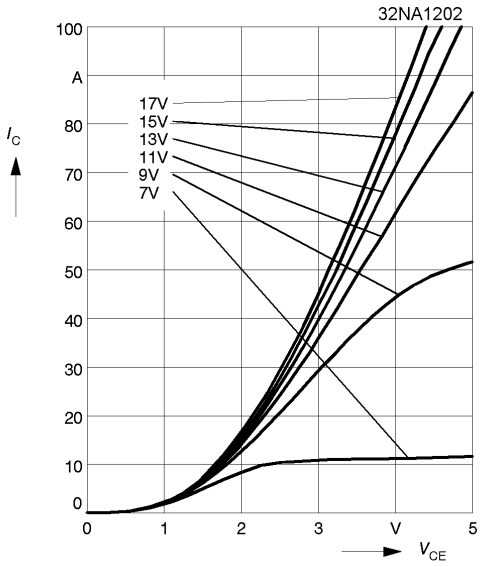
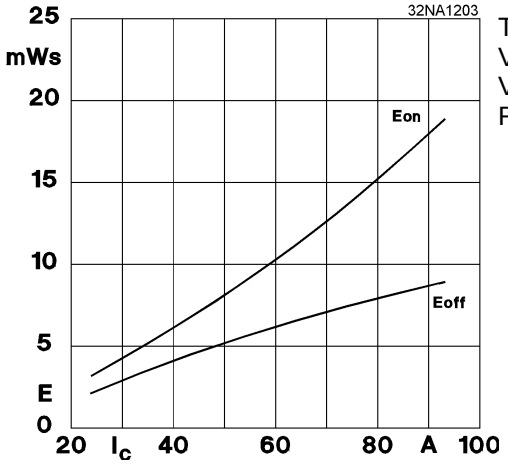
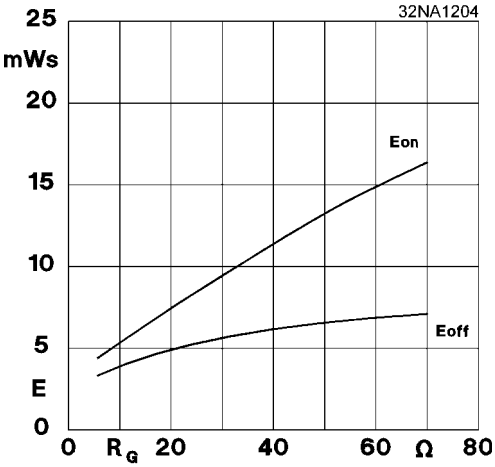


Fig. 2 Typ. output characteristic, t_p = 80 µs; 125 °C



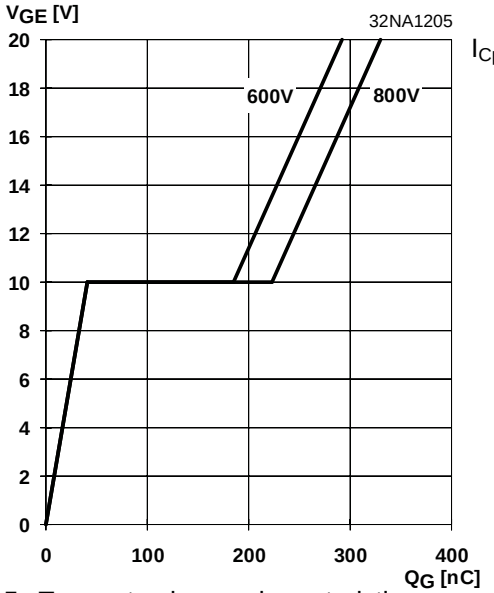
T_j = 125 °C
V_{CE} = 600 V
V_{GE} = ± 15 V
R_G = 22 Ω

Fig. 3 Turn-on /-off energy = f (I_C)



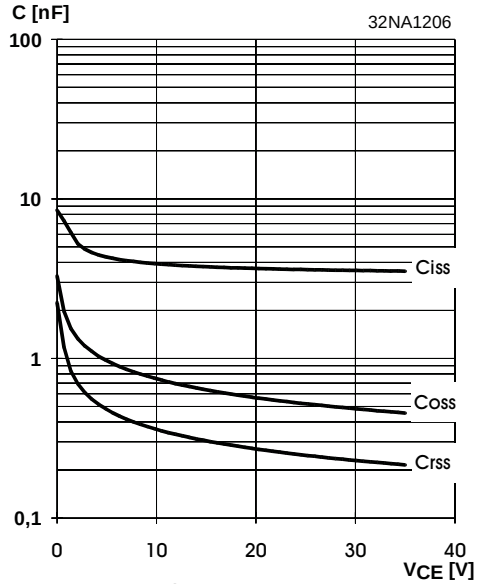
T_j = 125 °C
V_{CE} = 600 V
V_{GE} = ± 15 V
I_C = 50 A

Fig. 4 Turn-on /-off energy = f (R_G)



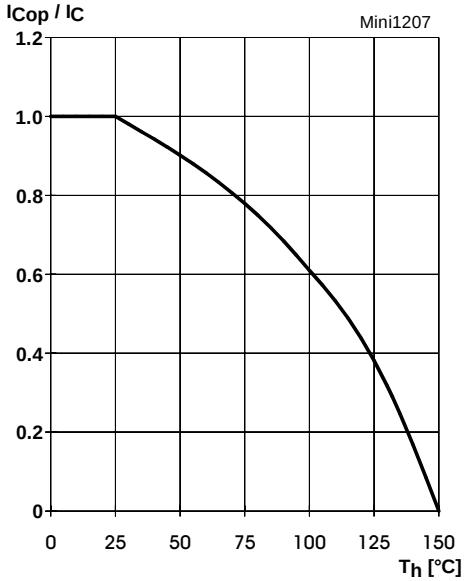
I_{Cpuls} = 50 A

Fig. 5 Typ. gate charge characteristic



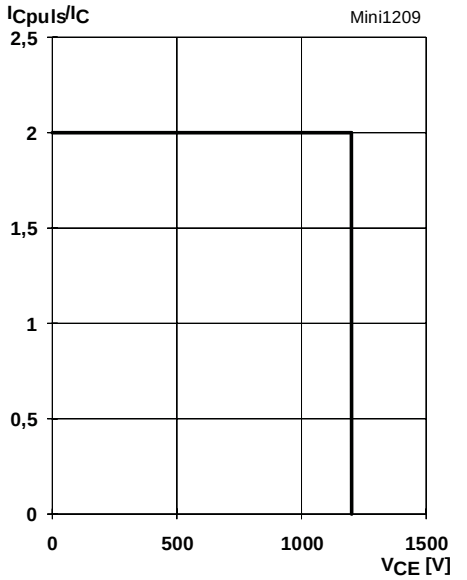
V_{GE} = 0 V
f = 1 MHz

Fig. 6 Typ. capacitances vs. V_{CE}



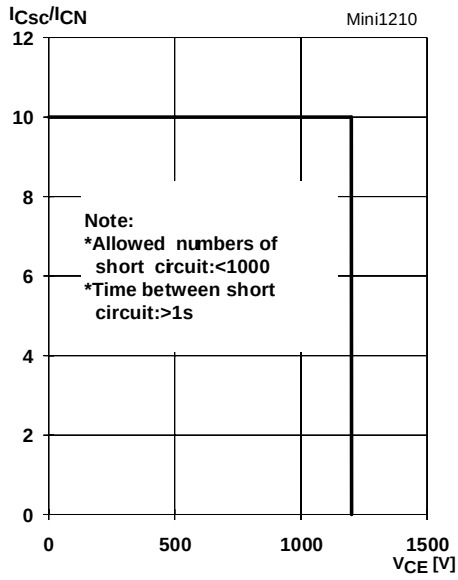
T_j = 150 °C
V_{GE} = ≥ 15 V

Fig. 7 Rated current of the IGBT $I_{Cop} / I_C = f(T_h)$



T_j = ≤ 150 °C
V_{GE} = ± 15 V

Fig. 9 Turn-off safe operating area (RBSOA) of the IGBT



T_j = ≤ 150 °C
V_{GE} = ± 15 V
t_{sc} = ≤ 10 µs
L_{ext} < 25 nH

Fig. 10 Safe operating area at short circuit of the IGBT

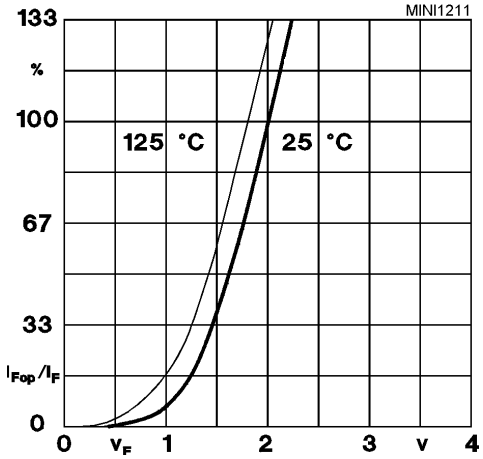


Fig. 11 Typ. freewheeling diode forward characteristic

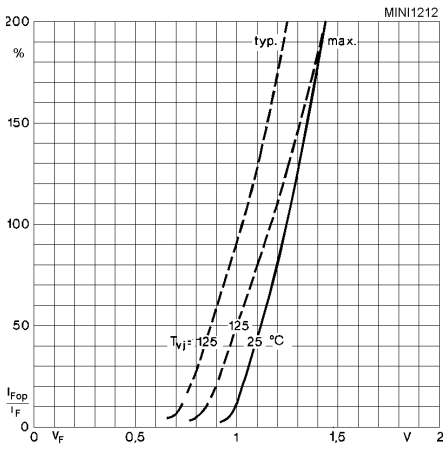


Fig. 12 Forward characteristic of the input bridge diode

MiniSKiiP 3

SKiiP 30 NAB 06	Circuit
SKiiP 31 NAB 06	Case M3
SKiiP 32 NAB 06	Layout and connections for the
SKiiP 30 NAB 12	customer's printed circuit board
SKiiP 31 NAB 12	
SKiiP 32 NAB 12